

MOTOROLA SC {XSTRS/R F}

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6367254 MOTOROLA SC {XSTRS/R F}

96D 82066 D

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	20	Vdc
Collector-Base Voltage	V _{CBO}	20	Vdc
Emitter-Base Voltage	V _{EBO}	3.0	Vdc

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board,* TA = 25°C Derate above 25°C	P _D	225	mW
		1.8	mW/°C
Thermal Resistance Junction to Ambient	R _{θJA}	556	°C/mW
Total Device Dissipation Alumina Substrate,** TA = 25°C Derate above 25°C	P _D	300	mW
		2.4	mW/°C
Thermal Resistance Junction to Ambient	R _{θJA}	417	°C/mW
Junction and Storage Temperature	T _J , T _{stg}	150	°C

*FR-5 = 1.0 x 0.75 x 0.62 in.

**Alumina = 0.4 x 0.3 x 0.024 in. 99.5% alumina.

DEVICE MARKING

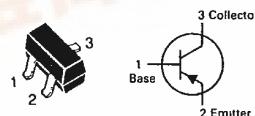
MMBTH81 = 3D

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector-Emitter Breakdown Voltage (I _C = 1.0 mAdc, I _B = 0)	V _{(BR)CEO}	20	—	—	Vdc
Collector-Base Breakdown Voltage (I _C = 10 μAdc, I _E = 0)	V _{(BR)CBO}	20	—	—	Vdc
Emitter-Base Breakdown Voltage (I _E = 10 μAdc, I _C = 0)	V _{(BR)EBO}	3.0	—	—	Vdc
Collector Cutoff Current (V _{CB} = 10 Vdc, I _E = 0)	I _{CBO}	—	—	100	nAdc
Emitter Cutoff Current (V _{BE} = 2.0 Vdc, I _C = 0)	I _{EBO}	—	—	100	nAdc
ON CHARACTERISTICS					
DC Current Gain (I _C = 5.0 mAdc, V _{CE} = 10 Vdc)	h _{FE}	60	—	—	—
Collector-Emitter Saturation Voltage (I _C = 5.0 mAdc, I _B = 0.5 mAdc)	V _{CE(sat)}	—	—	0.5	Vdc
Base-Emitter On Voltage (I _C = 5.0 mAdc, V _{CE} = 10 Vdc)	V _{BE(on)}	—	—	0.9	Vdc
SMALL-SIGNAL CHARACTERISTICS					
Current-Gain — Bandwidth Product (I _C = 5.0 mAdc, V _{CE} = 10 Vdc, f = 100 MHz)	f _T	600	—	—	MHz
Collector-Base Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 1.0 MHz)	C _{cb}	—	—	0.85	pF
Collector-Emitter Capacitance (I _B = 0, V _{CB} = 10 Vdc, f = 1.0 MHz)	C _{ce}	—	—	0.65	pF

MOTOROLA SMALL-SIGNAL SEMICONDUCTORS

T-31-15

MMBTH81CASE 318-02/03, STYLE 6
SOT-23 (TO-236AA/AB)**UHF/VHF TRANSISTOR**

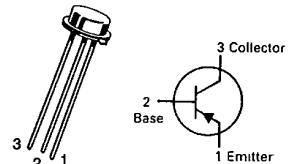
PNP SILICON



6367254 MOTOROLA SC (XSTRS/R F)

96D 82146 D

T29-19

2N2945**2N2946****CASE 26-03, STYLE 1
TO-46 (TO-206AB)****TRANSISTOR**

PNP SILICON

Refer to 2N2944A for graphs.

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Max	Unit	Min	Typ	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	87.5	$^\circ\text{C/W}$	—	—	—	—
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	435	$^\circ\text{C/W}$	—	—	—	—
OFF CHARACTERISTICS							
Collector Cutoff Current ($V_{CB} = 25 \text{ Vdc}, I_E = 0$) ($V_{CB} = 40 \text{ Vdc}, I_E = 0$)	I_{CBO}	2N2945 2N2946	— —	— —	0.2 0.5	nAdc	nAdc
Emitter Cutoff Current ($V_{EB} = 25 \text{ Vdc}, I_C = 0$) ($V_{EB} = 40 \text{ Vdc}, I_C = 0$)	I_{EBO}	2N2945 2N2946	— —	— —	0.2 0.5	nAdc	nAdc
ON CHARACTERISTICS							
DC Current Gain ($I_C = 1.0 \text{ mA}, V_{CE} = 0.5 \text{ Vdc}$)	h_{FE}	2N2945 2N2946	40 30	160 130	— —	— —	— —
*DC Current Gain (Inverted Connection) ($I_B = 200 \mu\text{Adc}, V_{EC} = 0.5 \text{ Vdc}$)	$h_{FE(\text{inv})}$	2N2945 2N2946	4.0 3.0	17 15	— —	— —	— —
Offset Voltage ($I_B = 200 \mu\text{Adc}, I_E = 0$) ($I_B = 1.0 \text{ mA}, I_E = 0$) ($I_B = 2.0 \text{ mA}, I_E = 0$)	$V_{EC(\text{ofs})}$	2N2945 2N2946 2N2945 2N2946 2N2945 2N2946	— — — — — —	0.23 0.27 0.5 0.6 0.9 1.0	0.5 0.8 1.0 2.0 1.6 2.5	mVdc	mVdc

SMALL-SIGNAL CHARACTERISTICS

Current-Gain — Bandwidth Product ($I_C = 1.0 \text{ mA}, V_{CE} = 6.0 \text{ Vdc}, f = 1.0 \text{ MHz}$)	2N2945 2N2946	f_T	5.0 3.0	13 12	— —	MHz
Output Capacitance ($V_{CB} = 6.0 \text{ Vdc}, I_E = 0, f = 500 \text{ kHz}$)	C_{obo}	—	—	3.2	10	pF
Input Capacitance ($V_{EB} = 6.0 \text{ Vdc}, I_C = 0, f = 500 \text{ kHz}$)	C_{ibo}	—	—	1.9	6.0	pF
"ON" Series Resistance ($I_B = 1.0 \text{ mA}, I_E = 0, I_C = 100 \mu\text{Adc}, f = 1.0 \text{ kHz}$)	2N2945 2N2946	r_{ec}	— —	4.5 5.0	35 45	Ohms

*Indicates Data in addition to JEDEC Requirements.

6367254 MOTOROLA SC (XSTRS/R F)

MAXIMUM RATINGS

Rating	Symbol	2N3734	2N3735 2N3737	Unit
Collector-Emitter Voltage	V _{CEO}	30	50	Vdc
Collector-Base Voltage	V _{CBO}	50	75	Vdc
Emitter-Base Voltage	V _{EBO}		5.0	Vdc
Collector Current --- Continuous	I _C		1.5	Adc
		TO-39 2N3734 2N3735	TO-46 2N3737	
Total Device Dissipation @ T _A = 25°C Derate above 25°C	PD	1.0 5.71	0.5 2.86	Watt mW/°C
Total Device Dissipation @ T _C = 25°C Derate above 25°C	PD	4.0 22.8	2.0 11.4	Watts mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{Stg}	-65 to +200		°C

THERMAL CHARACTERISTICS

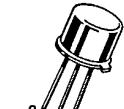
Characteristic	Symbol	2N3734	2N3735 2N3737	Unit
Thermal Resistance, Junction to Case	R _{θJC}	0.044	0.088	°C/mW
Thermal Resistance, Junction to Ambient	R _{θJA}	0.175	0.35	°C/mW

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted.)

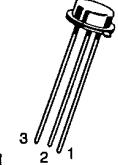
Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
(I _C = 10 mAdc, I _B = 0)				
Collector-Emitter Breakdown Voltage(1)	V _{(BR)CEO}	30	—	Vdc
2N3734 2N3735, 2N3737	50	—		
Collector-Base Breakdown Voltage (I _C = 10 μAdc, I _E = 0)	V _{(BR)CBO}	50	—	Vdc
2N3734 2N3735, 2N3737	75	—		
Emitter-Base Breakdown Voltage (I _E = 10 μAdc, I _C = 0)	V _{(BR)EBO}	5.0	—	Vdc
Collector Cutoff Current (V _{CE} = 25 Vdc, V _{EB} = 2 Vdc) (V _{CE} = 25 Vdc, V _{EB} = 2 Vdc, T _A = 100°C) (V _{CE} = 40 Vdc, V _{EB} = 2 Vdc) (V _{CE} = 40 Vdc, V _{EB} = 2 Vdc, T _A = 100°C)	I _{CEX}	— — — —	0.20 20 0.20 20	μAdc
Base Cutoff Current (V _{CE} = 25 Vdc, V _{EB} = 2 Vdc) (V _{CE} = 40 Vdc, V _{EB} = 2 Vdc)	I _{BL}	— —	0.3 0.3	μAdc
ON CHARACTERISTICS				
(I _C = 10 mAdc, V _{CE} = 1 Vdc)				
(I _C = 150 mAdc, V _{CE} = 1 Vdc)	h _{FE}	35	—	—
(I _C = 500 mAdc, V _{CE} = 1 Vdc)		40	—	
(I _C = 1 Adc, V _{CE} = 1.5 Vdc)	2N3734 2N3735, 2N3737	35	—	
(I _C = 1.5 Adc, V _{CE} = 5 Vdc)	2N3734 2N3735, 2N3737	30 20	120 80	—
Collector-Emitter Saturation Voltage(1) (I _C = 10 mAdc, I _B = 1 mAdc) (I _C = 150 mAdc, I _B = 15 mAdc) (I _C = 500 mAdc, I _B = 50 mAdc) (I _C = 1 Adc, I _B = 100 mAdc)	V _{CE(sat)}	— — — —	0.2 0.3 0.5 0.9	Vdc
Base-Emitter Saturation Voltage(1) (I _C = 10 mAdc, I _B = 1 mAdc) (I _C = 150 mAdc, I _B = 15 mAdc) (I _C = 500 mAdc, I _B = 50 mAdc) (I _C = 1 Adc, I _B = 100 mAdc)	V _{BE(sat)}	— — — —	0.8 1.0 1.2 1.4	Vdc

96D 82220 D

T-35-7

2N3734
2N3735CASE 79-02, STYLE 1
TO-39 (TO-205AD)

2N3737

CASE 26-03, STYLE 1
TO-46 (TO-206AD)GENERAL PURPOSE
TRANSISTOR

NPN SILICON

Refer to 2N3725 for graphs.

6367254 MOTOROLA SC (XSTRS/R F)

96D 82221 D

2N3737

T-35-17

ELECTRICAL CHARACTERISTICS (continued) ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
SMALL-SIGNAL CHARACTERISTICS				
Output Capacitance ($V_{CB} = 10 \text{ Vdc}, I_E = 0, f = 100 \text{ kHz}$)	C_{obo}	—	9.0	pF
Input Capacitance ($V_{BE} = 0.5 \text{ Vdc}, I_C = 0, f = 100 \text{ kHz}$)	C_{ibo}	—	80	pF
Small-Signal Current Gain ($I_C = 50 \text{ mA dc}, V_{CE} = 10 \text{ Vdc}, f = 100 \text{ MHz}$)	h_{fe}	2.5	—	—
SWITCHING CHARACTERISTICS				
Turn-On Time ($V_{CC} = 30 \text{ V}, V_{BE(off)} = 2.0 \text{ V}, I_C = 1.0 \text{ Amp}, I_{B1} = 100 \text{ mA}$)	t_{on}	—	40	ns
Turn-Off Time ($V_{CC} = 30 \text{ V}, V_{BE(off)} = 2.0 \text{ V}, I_C = 1.0 \text{ Amp}, I_{B1} = 100 \text{ mA}$)	t_{off}	—	60	ns
Total Control Charge ($I_C = 1 \text{ Amp}, I_B = 100 \text{ mA}, V_{CC} = 30 \text{ V}$)	Q_T	—	10	NC

(1) Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$.